

# NRVTS245ESF

## Very Low Forward Voltage Trench-based Schottky Rectifier

### Features

- Fine Lithography Trench-based Schottky Technology for Very Low Forward Voltage and Low Leakage
- Fast Switching with Exceptional Temperature Stability
- Low Power Loss and Lower Operating Temperature
- Higher Efficiency for Achieving Regulatory Compliance
- Low Thermal Resistance
- High Surge Capability
- NRV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These are Pb-Free and Halide-Free Devices

### Mechanical Characteristics:

- Case: Molded Epoxy
- Epoxy Meets UL 94 V-0 @ 0.125 in
- Weight: 11.7 mg (Approximately)
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Maximum for 10 Seconds
- MSL 1

### Typical Applications

- Switching Power Supplies including Compact Adapters and Flat Panel Display
- High Frequency and DC-DC Converters
- Freewheeling and OR-ing diodes
- Reverse Battery Protection
- Instrumentation
- Automotive LED Lighting



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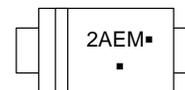
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**TRENCH SCHOTTKY  
RECTIFIER  
2.0 AMPERES  
45 VOLTS**



SOD-123FL  
CASE 498  
PLASTIC

### MARKING DIAGRAM



2AE = Specific Device Code  
M = Date Code  
▪ = Pb-Free Package  
(Note: Microdot may be in either location)

### ORDERING INFORMATION

| Device         | Package              | Shipping†              |
|----------------|----------------------|------------------------|
| NRVTS245ESFT1G | SOD-123<br>(Pb-Free) | 3,000/<br>Tape & Reel  |
| NRVTS245ESFT3G | SOD-123<br>(Pb-Free) | 10,000/<br>Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

# NRVTS245ESF

## MAXIMUM RATINGS

| Rating  | Symbol                          | Value       | Unit             |
|---|---------------------------------|-------------|------------------|
| Peak Repetitive Reverse Voltage<br>Working Peak Reverse Voltage<br>DC Blocking Voltage                      | $V_{RRM}$<br>$V_{RWM}$<br>$V_R$ | 45          | V                |
| Average Rectified Forward Current<br>( $T_L = 148^\circ\text{C}$ )  | $I_O$                           | 2.0         | A                |
| Peak Repetitive Forward Current<br>(Square Wave, 20 kHz, $T_L = 143^\circ\text{C}$ )                        | $I_{FRM}$                       | 4.0         | A                |
| Non-Repetitive Peak Surge Current<br>(Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz) | $I_{FSM}$                       | 50          | A                |
| Storage and Operating Junction Temperature Range (Note 1)   | $T_{stg}, T_J$                  | -65 to +175 | $^\circ\text{C}$ |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- The heat generated must be less than the thermal conductivity from Junction-to-Ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ .

## THERMAL CHARACTERISTICS

| Characteristic                                   | Symbol          | Value | Unit               |
|--|-----------------|-------|--------------------|
| Thermal Resistance, Junction-to-Lead (Note 2)    | $\Psi_{JCL}$    | 23    | $^\circ\text{C/W}$ |
| Thermal Resistance, Junction-to-Ambient (Note 2) | $R_{\theta JA}$ | 85    | $^\circ\text{C/W}$ |
| Thermal Resistance, Junction-to-Ambient (Note 3) | $R_{\theta JA}$ | 330   | $^\circ\text{C/W}$ |

## ELECTRICAL CHARACTERISTICS

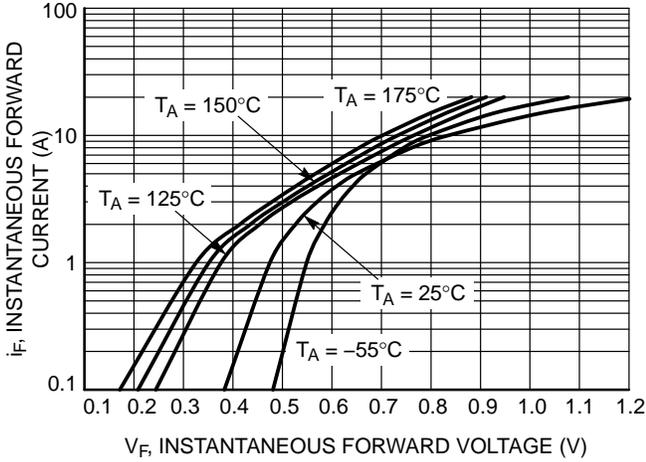
| Characteristic  | Symbol | Value        | Unit                |
|---|--------|--------------|---------------------|
| Maximum Instantaneous Forward Voltage (Note 4)<br>( $I_F = 2.0 \text{ A}, T_J = 25^\circ\text{C}$ )<br>( $I_F = 2.0 \text{ A}, T_J = 125^\circ\text{C}$ ) | $V_F$  | 0.65<br>0.58 | V                   |
| Maximum Instantaneous Reverse Current (Note 4)<br>(Rated dc Voltage, $T_J = 25^\circ\text{C}$ )<br>(Rated dc Voltage, $T_J = 125^\circ\text{C}$ )         | $I_R$  | 75<br>3      | $\mu\text{A}$<br>mA |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

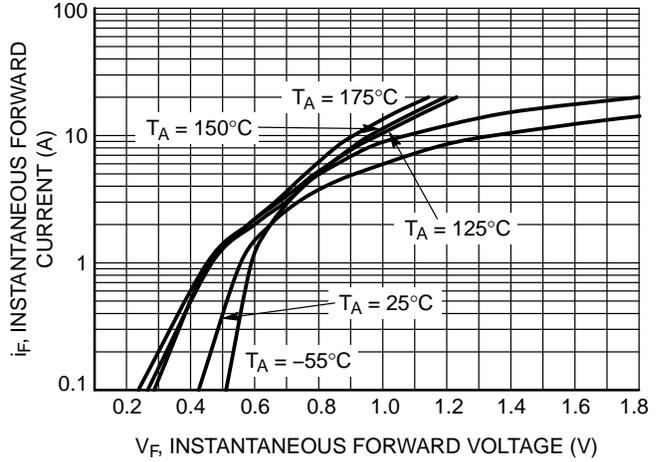
- Mounted with 700 mm<sup>2</sup> copper pad size (Approximately 1 in<sup>2</sup>) 1 oz FR4 Board.
- Mounted with pad size approximately 20 mm<sup>2</sup> copper, 1 oz FR4 Board.
- Pulse Test: Pulse Width  $\leq 380 \mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .

# NRVTS245ESF

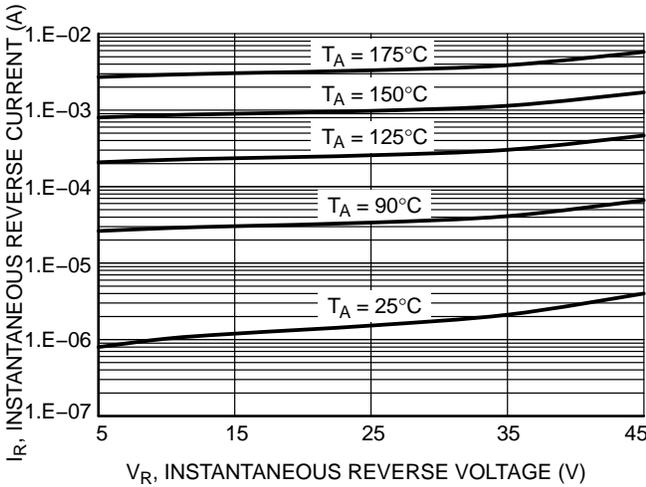
## TYPICAL CHARACTERISTICS



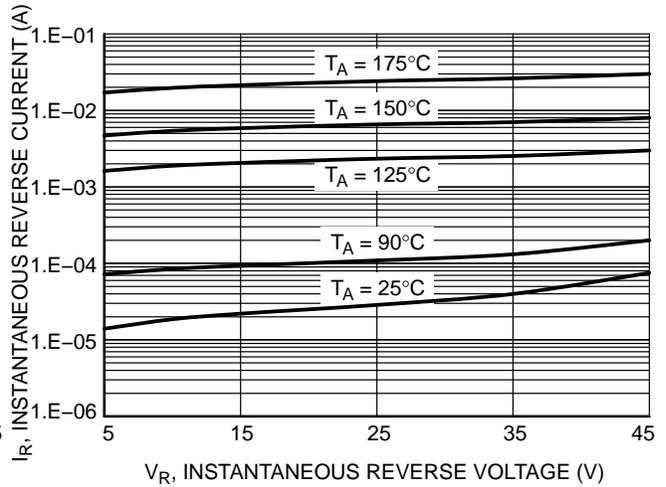
**Figure 1. Typical Instantaneous Forward Characteristics**



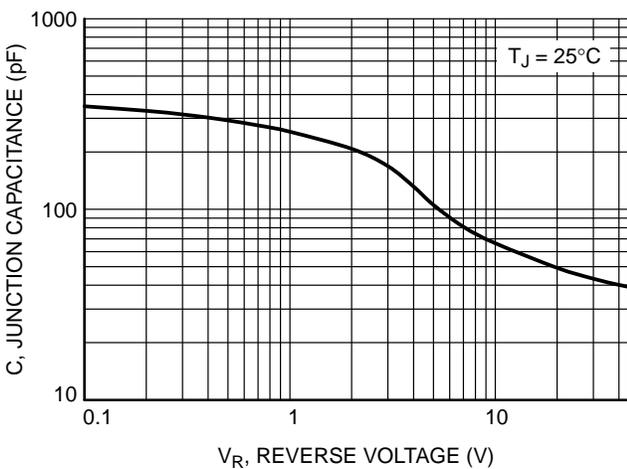
**Figure 2. Maximum Instantaneous Forward Characteristics**



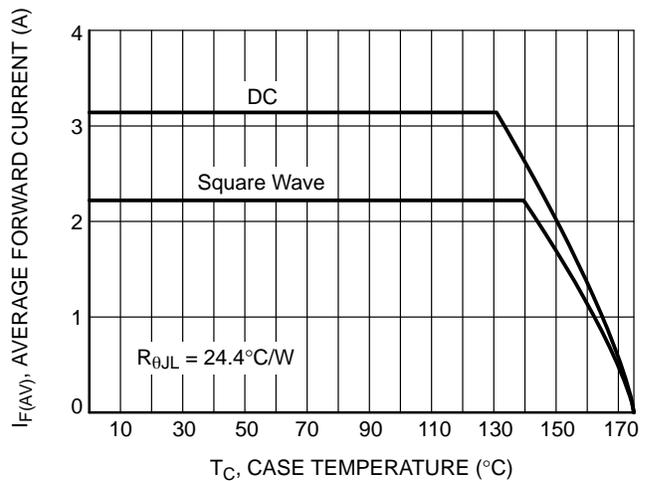
**Figure 3. Typical Reverse Characteristics**



**Figure 4. Maximum Reverse Characteristics**



**Figure 5. Typical Junction Capacitance**



**Figure 6. Current Derating**

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## TYPICAL CHARACTERISTICS

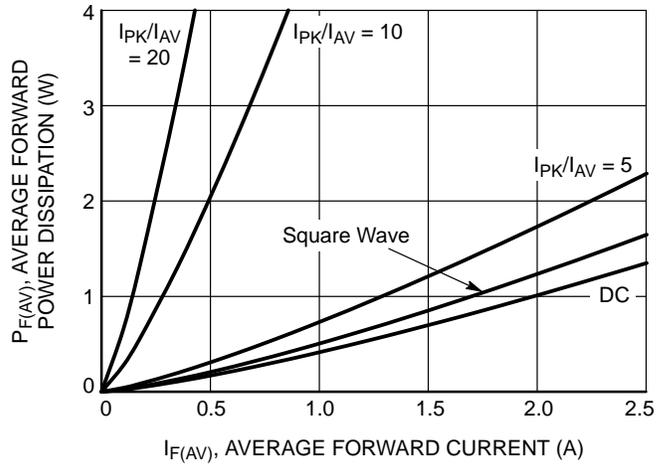


Figure 7. Forward Power Dissipation

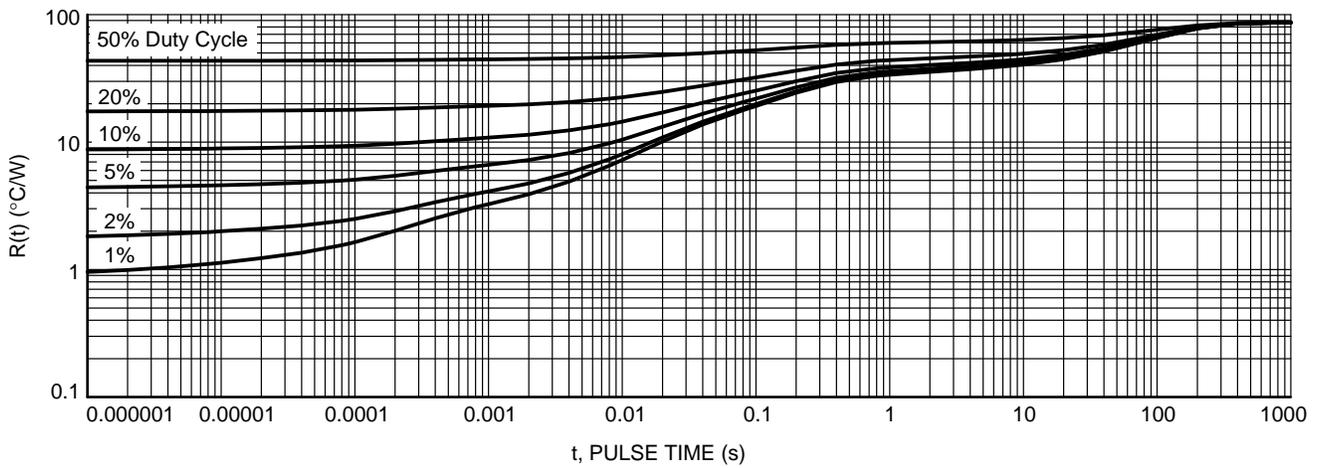
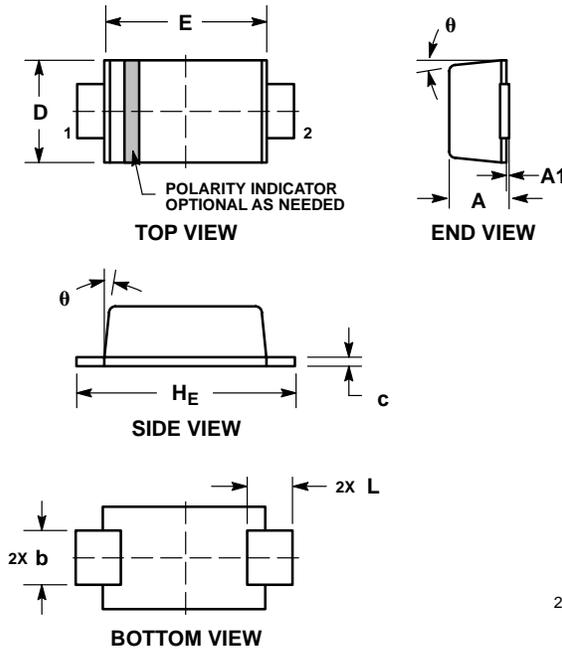


Figure 8. Thermal Characteristics

# NRVTS245ESF

## PACKAGE DIMENSIONS

SOD-123FL  
CASE 498  
ISSUE D

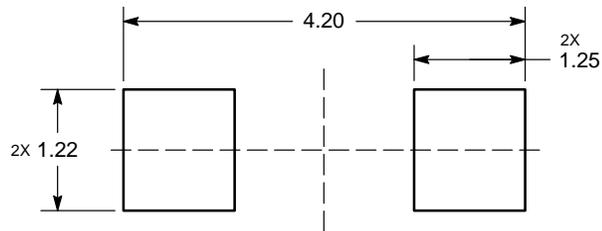


**NOTES:**

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH.
4. DIMENSIONS D AND J ARE TO BE MEASURED ON FLAT SECTION OF THE LEAD: BETWEEN 0.10 AND 0.25 MM FROM THE LEAD TIP.

| DIM            | MILLIMETERS |      |      | INCHES |       |       |
|----------------|-------------|------|------|--------|-------|-------|
|                | MIN         | NOM  | MAX  | MIN    | NOM   | MAX   |
| A              | 0.90        | 0.95 | 0.98 | 0.035  | 0.037 | 0.039 |
| A1             | 0.00        | 0.05 | 0.10 | 0.000  | 0.002 | 0.004 |
| b              | 0.70        | 0.90 | 1.10 | 0.028  | 0.035 | 0.043 |
| c              | 0.10        | 0.15 | 0.20 | 0.004  | 0.006 | 0.008 |
| D              | 1.50        | 1.65 | 1.80 | 0.059  | 0.065 | 0.071 |
| E              | 2.50        | 2.70 | 2.90 | 0.098  | 0.106 | 0.114 |
| L              | 0.55        | 0.75 | 0.95 | 0.022  | 0.030 | 0.037 |
| H <sub>E</sub> | 3.40        | 3.60 | 3.80 | 0.134  | 0.142 | 0.150 |
| θ              | 0°          | -    | 8°   | 0°     | -     | 8°    |

### RECOMMENDED SOLDERING FOOTPRINT\*



DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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**Телефон:** 8 (812) 309 58 32 (многоканальный)

**Факс:** 8 (812) 320-02-42

**Электронная почта:** [org@eplast1.ru](mailto:org@eplast1.ru)

**Адрес:** 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.